



Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F Max (V)	I _R Max (μA)
1200	1	2.0	5

Description

The US1NWFQ is an automotive-compliant rectifier in the SOD123F package. The device is ideal as a boost diode in power factor correction circuitry, and for use in secondary rectification and freewheeling for AC-AC and DC-DC converters in high-temperature conditions.

Applications

- Flat panel displays
- Switching power supplies/chargers
- LED lighting
- Freewheeling diodes

1.0A SURFACE MOUNT ULTRA-FAST RECTIFIER

Features and Benefits

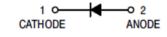
- Low Profile, Small Form Factor Package
- Low Leakage Current
- Glass Passivated Die Construction
- Ultra-Fast Recovery Times for High Efficiency
- Low Forward Voltage, Low Power Loss
- Lead-Free Finish & RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The US1NWFQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOD123F
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.016 grams (Approximate)





Top View



Ordering Information (Note 4)

Orderable Part Number	Bookago	Pacl	king
Orderable Part Number	Package	Quantity	Carrier
US1NWFQ-7	SOD123F	3,000	Tape & Reel

SOD123F

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

	SOD12	3F	
Ī	114	М	

U1 = Product Type Marking Code

YM = Date Code Marking

Y = Year (ex: K = 2023)

M = Month (ex: 9 = September)

Date	Code	Kev
Date	COUE	1109

Date Code Key												
Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	K	L	М	N	Р	R	S	Т	U	V	W	Х
	1				1		1	1	1	r	1	
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} VR	1200	V
Average Rectified Output Current	lo	1	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	30	А

Thermal Characteristics

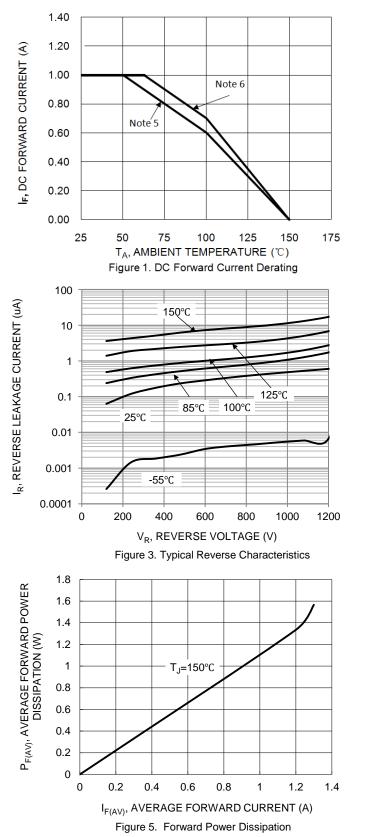
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	33	°C/W
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{0JA}	100	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{0JA}	82	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	С°

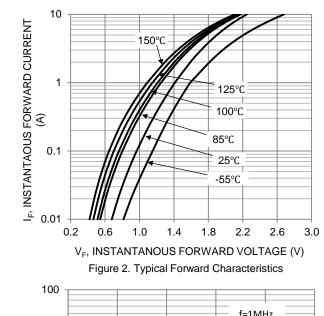
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

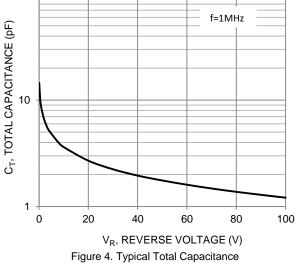
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	1200	—	—	V	I _R = 10μA
Forward Voltage	V _F	_	1.3 1.4 1.5	1.7 1.9 2.0	V	I _F = 0.5A, T _J = +25°C I _F = 0.8A, T _J = +25°C I _F = 1A, T _J = +25°C
Reverse Leakage Current (Note 7)	I _R		0.5 10	5 100	μA	V _R = 1200V, T _J = +25°C V _R = 1200V, T _J = +125°C
Reverse Recovery Time	t _{RR}	_	70	80	ns	I _F = 0.5A, I _R = 1.0A, I _{RR} = 0.25A
Total Capacitance	CT		5		pF	$V_R = 4V$, f=1MHz

Notes: 5. Device mounted on FR-4 substrate, 25.4*25.4mm, 2oz, single-sided, PC boards with 2.1*2.1mm copper. 6. Device mounted on FR-4 substrate, 0.4**0.5", 2oz, single-sided, PC boards with 0.2**0.25" copper pad. 7. Short duration pulse test used to minimize self-heating effect.





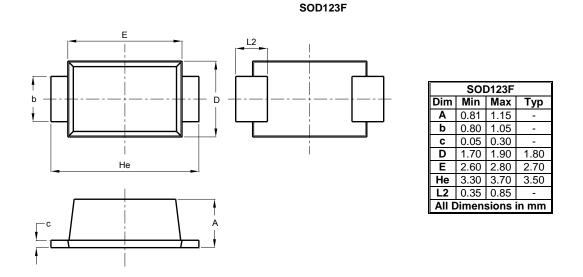






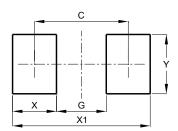
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	2.86
G	1.52
Х	1.34
X1	4.20
Y	1.80

SOD123F



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